06-09-1999 FORM PTO-1595 EUS DEEARIMENT DEE 1-31-92 R SHEET LY 101057215 To the Assistant Commissioner of Patents. Please record the attached original documents or hereof. Name of conveying party(ies): 2. Name and address of receiving party(ies): YOSHIAKI OIKAWA, MITSUYUKI HATANAKA, and KENZO AKAGIRI SONY CORPORATION Internal Address: Tokyo International P.O. Box 5100, Tokyo Additional name(s) of conveying party(ies) attached? 100-31, Japan Yes Street Address: 7-35, Kitashinagawa 6-chome, Shinagawa-ku Nature of Conveyance: City Tokyo 141 Country Japan Assignment Security Agreement Change of Name Additional Name(s) & address(es) attached? Other _ Yes Execution Date: May 13, 1999; May 14, 1999 and May 17, 1999 Application number(s) or patent number(s): Patent Application No.(s): 09/254,766 Patent No.(s) International Filing Date: July 10, 1998 Additional numbers attached? Yes Name and address of party to whom correspondence concerning 6. Total number of applications and patents involved: 1 document should be mailed: Mayumi Maeda 7. Total fee (37 CFR 3.41):.....\$ 40.00 Internal Address: Limbach & Limbach L.L.P. Enclosed Street Address: 2001 Ferry Building City, State, ZIP: San Francisco, California 94111 Authorized to be charged to deposit account Telephone: (415) 433-4150 Facsimile: (415) 433-8716 8. Deposit account number: 12-1420 Attorney Docket No. KOIK-P8759 (Attach duplicate copy of this page if paying by deposit account) DO NOT USE THIS SPACE Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. June 3, 1999 Name of Person Signing Date Total number of pages comprising cover sheet: 1 OMB No. 0651-0011 (exp 4/94) Do not detach this portion Mail documents to be recorded with required cover sheet information to: 06/09/1999 DNGUYEN 00000105 09254766

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Commissioner of Patents and Trademarks

Box Assignments Washington, D.C. 20231

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ASSIGNMENT

Docket Number: KOIK-P8759

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in INFORMATION CODING METHOD AND DEVICE, AND PROVIDING MEDIUM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo 141-0001, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: <u>09/254,766</u>, Filing Date: <u>July 10, 1998 (International Filing Date)</u>

This assignment executed on the dates indicated below.

YOSHIAKI OIKAWA	
Name of first or sole inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of first or sole inventor	
Yoshaki Vikawa	May 13, 1999
Signature of first or sole inventor	Date of this assignment

PATENT REEL: 010000 FRAME: 0248

MITSUYUKI HATANAKA	
Name of second inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of second inventor	
Mutseyecki Hatanaha Signature of second inventor	May 14, 1999
Signature of second inventor	Date of this assignment
KENZO AKAGIRI	
Name of third inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of third inventor	
Signature of third inventor	May 17 1996) Date of this assignment
Signature of third inventor	Date of this assignment
Name of fourth inventor	Execution date of U.S. Patent Application
Residence of fourth inventor	
Signature of fourth inventor	Date of this assignment
Name of fifth inventor	Execution date of U.S. Patent Application
Residence of fifth inventor	
Signature of fifth inventor	Date of this assignment

PATENT RECORDED: 06/07/1999 REEL: 010000 FRAME: 0249

Date of this assignment